

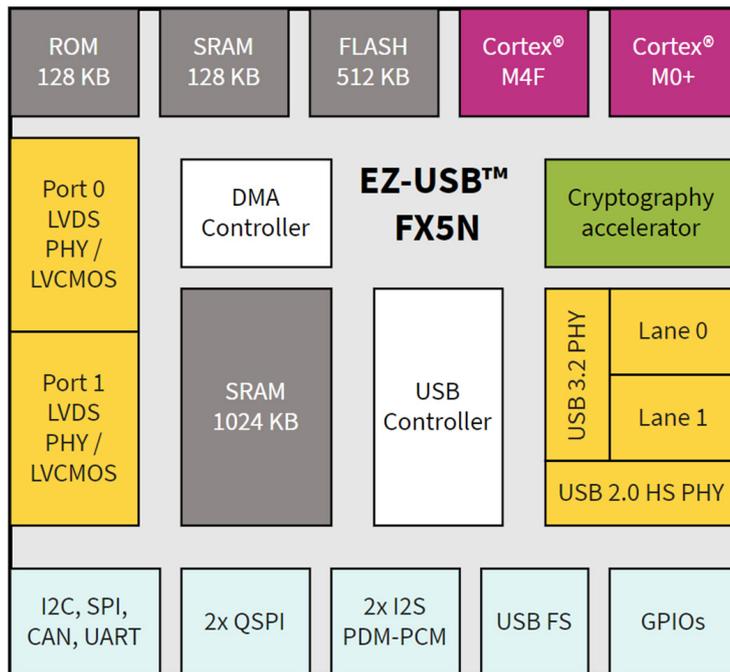
EZ-USB™ FX5N

USB 10Gbps peripheral controller

USB 10Gbps to high-bandwidth LVDS/LVCMOS data interface with dual-core ARM® Cortex® CPU and direct USB-C support

Infineon's EZ-USB™ FX5N extends the legacy of EZ-USB™ FX3, the industry's gold standard for USB peripheral controller, with faster GPIF and LVDS interfaces increasing the total bandwidth to max out USB 10Gbps.

The EZ-USB™ FX5N is a general-purpose peripheral controller capable of transferring data over two lanes of 5 Gbps pipes from an existing USB 5Gbps USB-C cable providing 10 Gbps total bandwidth for the new-generation USB applications in camera, video, imaging, and data acquisition markets. EZ-USB™ FX5N consists of dual ARM® Cortex®-M4 and M0+ core CPUs, a 512 KB flash, an 128 KB SRAM, an 128 KB ROM, seven serial communication blocks (SCBs), a cryptography accelerator, and a high bandwidth data subsystem providing DMA data transfers between LVDS/ LVCMOS and USB ports at speeds up to 10 Gbps. An additional 1 MB SRAM is included in the high bandwidth data subsystem to provide buffering for USB data.



Key features

USB 3.2 Gen 1 x2 device port

- Integrated PHY: 10 Gbps (5 Gbps x2), 5 Gbps, 480 Mbps
- USB-C plug orientation detection and correction

Dual-core CPU

- 150 MHz ARM® Cortex®-M4F
- 100 MHz ARM® Cortex®-M0+

Memory subsystem

- 512 KB flash
- 1024 KB + 128 KB SRAM

Dual-mode high bandwidth data interface

- LVDS / SubLVDS: up to 16 RX data lanes @1.25 Gbps
- LVCMOS: up to 32-bit data bus @ 160 MHz DDR RX

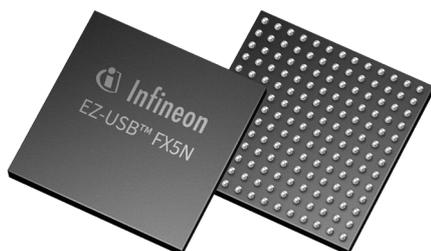
Peripheral I/O ports

- 2x Quad-SPI (QSPI)
- 7 serial communication blocks (I²C, SPI, CAN, UART)
- USB full-speed (12 Mbps) device
- 2x I²S/PDM-PCM and GPIOs

Cryptography accelerator

Package

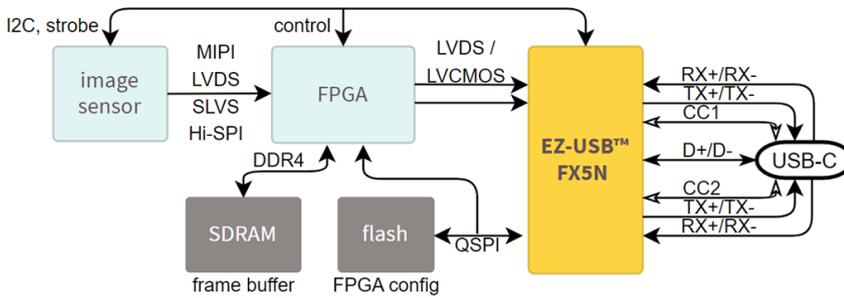
- 10 mm x 10 mm, 169-ball, 0.75 mm ball pitch



PRODUCT BRIEF

Application example: machine vision camera

The 5 Gbps performance allows uncompressed 4K videos to be transmitted at 30 frame-per-second. Both USB 5Gbps lanes of EZ-USB™ FX5N can be connected directly to a USB-C receptacle without a mux. The controller can automatically detect the plug orientation, transfer data to the active lane, and correct the polarity of each USB 5Gbps differential pair. An FPGA is connected between a high-speed image sensor and EZ-USB™ FX5N to perform image acquisition and processing, and transfers images to the controller via LVDS or LVCMOS connection. For LVDS mode, each lane can support up to 1.25 Gbps. For LVCMOS mode, the 32-bit data bus can deliver 10 Gbps throughput with DDR clocking. EZ-USB™ FX5N DMA fabric allows maximum USB 5Gbps bandwidth to be used with auto header and trailer insertion.



Key benefits

- Smaller PCB footprint and optimized BOM cost 10x10 BGA package
- USB-C direct connection without a high-speed signal mux
- Integrated FLASH
- Quick start development
- Firmware jumpstart with configuration utility
- USB Video Class, UVC, firmware ready
- USB3 Vision firmware ready
- DVK with standard FMC for quick connection to FPGA boards
- All-in-one programming and debugging accessory board
- Application notes for hardware and software

EZ-USB™ FX5N part detail

Part number	USB-C	LVDS	LVCMOS	QSPI	Crypto	FLASH [KB]	SRAM [KB]
CYUSB3282B0	✓	✓	✓			256 KB	512 KB
CYUSB3284B0	✓	✓	✓	✓	✓	512 KB	1024 KB



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